

ISL267452

12-Bit, 555kSPS SAR ADC

FN8255
Rev 0.00
July 26, 2012

The ISL267452 is a 12-bit, 555kSPS sampling SAR-type ADC featuring excellent linearity over supply and temperature variations, and is drop-in compatible with the AD7452. The robust, fully-differential input offers high impedance to minimize errors due to leakage currents, and the specified measurement accuracy is maintained with input signals up to the supply rails.

The reference accepts inputs from 0.1V to 2.2V for 3V operation and 0.1V to 3.5V for 5V operation, which provides design flexibility in a wide variety of applications. The ISL267452 also features up to 8kV Human Body Model ESD survivability.

The serial digital interface is SPI compatible and is easily interfaced to all popular FPGAs and microcontrollers. Power dissipation is 7mW at a sampling rate of 555kSPS, and just 5µW between conversions utilizing Auto Power-Down mode (with a 5V supply), making the ISL267452 an excellent solution for remote industrial sensors and battery-powered instruments.

The ISL267452 is available in an 8 LD SOT-23 package, and is specified for operation over the Industrial temperature range (-40°C to +85°C).

Features

- Drop-in Compatible with AD7452
- Differential Input (Span = 2VREF)
- Simple SPI-compatible Serial Digital Interface
- Guaranteed No Missing Codes
- 555kHz Sampling Rate
- 3V or 5V Operation
- Low Operating Current
 - 1.25mA at 555kSPS with 3V Supplies
 - 1.70mA at 555kSPS with 5V Supplies
- Power-down Current between Conversions: 1µA
- Excellent Differential Non-Linearity
- Low THD: -83dB (typ)
- Pb-Free (RoHS Compliant)
- Available in SOT-23 Package

Applications

- Remote Data Acquisition
- Battery Operated Systems
- Industrial Process Control
- Energy Measurement
- Data Acquisition Systems
- Pressure Sensors
- Flow Controllers

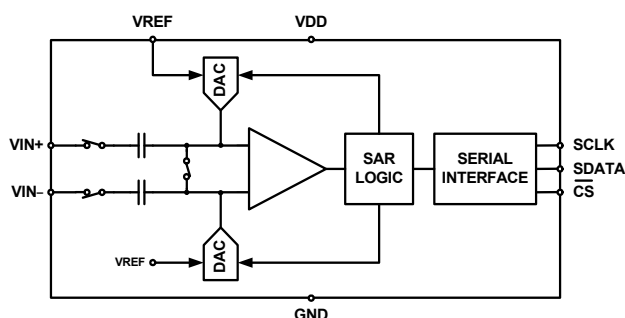


FIGURE 1. BLOCK DIAGRAM

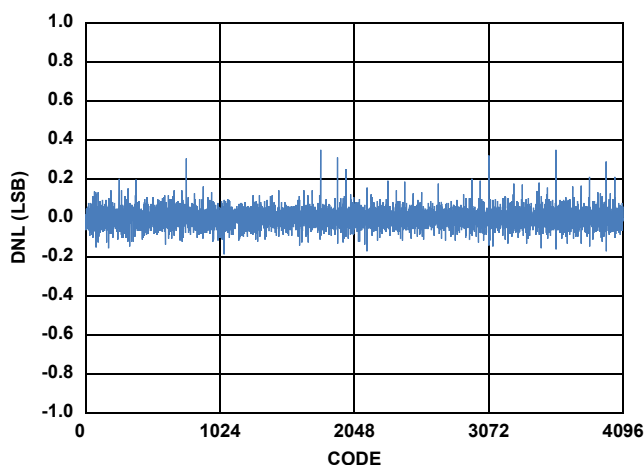
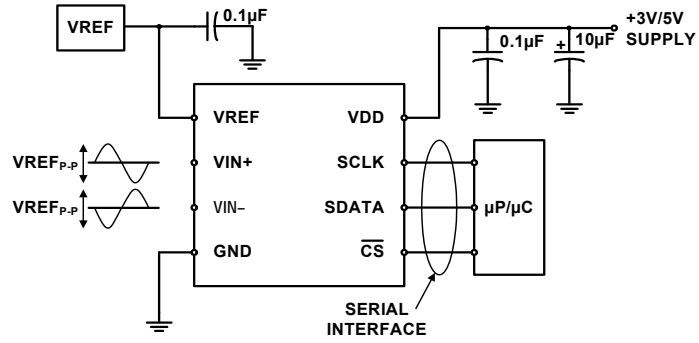


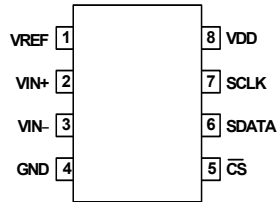
FIGURE 2. DIFFERENTIAL LINEARITY ERROR vs CODE

Typical Connection Diagram



Pin Configuration

ISL267452
(8 LD SOT-23)
TOP VIEW



Pin Descriptions

ISL267452		DESCRIPTION
PIN NAME	PIN NUMBER	
VDD	8	Supply voltage, +2.7V to 5.25V.
SCLK	7	Serial clock input. Controls digital I/O timing and clocks the conversion.
SDATA	6	Digital conversion output.
\overline{CS}	5	Chip select input. Controls the start of a conversion.
GND	4	Ground
VIN-	3	Negative analog input.
VIN+	2	Positive analog input.
VREF	1	Reference voltage.

Ordering Information

PART NUMBER (Notes 1, 2, 3)	PART MARKING	VDD RANGE (V)	TEMP RANGE (°C)	PACKAGE Tape & Reel (Pb-free)	PKG. DWG. #
ISL267452IHZ-T	7452 (Note 4)	2.7 to 5.25	-40 to +85	8 Ld SOT-23	P8.064
ISL267452IHZ-T7A	7452 (Note 4)	2.7 to 5.25	-40 to +85	8 Ld SOT-23	P8.064

NOTES:

1. Please refer to [IB347](#) for details on reel specifications.
2. These Intersil Pb-free plastic packaged products employ special Pb-free material sets; molding compounds/die attach materials and NiPdAu plate -e4 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
3. For Moisture Sensitivity Level (MSL), please see device information page for [ISL267452](#). For more information on MSL please see techbrief [TB363](#).
4. The part marking is located on the bottom of the part.

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Absolute Maximum Ratings

Any Pin to GND	-0.3V to +6.0V
Analog Input to GND	-0.3V to VDD+0.3V
Digital I/O to GND	-0.3V to VDD+0.3V
Digital Input Voltage to GND	-0.3V to VDD+0.3V
Maximum Current In to Any Pin	10mA
ESD Rating	
Human Body Model (Tested per JESD22-A114F)	8kV
Machine Model (Tested per JESD22-A115B)	400V
Charged Device Model (Tested per JESD22-C101E)	1.5kV
Latch Up (Tested per JESD78C; Class 2, Level A)	100mA

Thermal Information

Thermal Resistance (Typical)	θ_{JA} (°C/W)	θ_{JC} (°C/W)
8 Ld SOT-23 Package (Notes 5, 6)	135	99
Operating Temperature	-40°C to +85°C	
Storage Temperature	-65°C to +150°C	
Junction Temperature	+150°C	
Pb-Free Reflow Profile	see link below http://www.intersil.com/pbfree/Pb-FreeReflow.asp	

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTES:

- θ_{JA} is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief [TB379](#) for details.
- For θ_{JC} , the “case temp” location is taken at the package top center.

Electrical Specifications VDD = +3.0V to +3.6V, $f_{SCLK} = 10\text{MHz}$, $f_S = 555\text{kSPS}$, VREF = 2.0V; VDD = +4.75V to +5.25V, $f_{SCLK} = 10\text{MHz}$, $f_S = 555\text{kSPS}$, VREF = 2.5V; $V_{CM} = V_{REF}$, unless otherwise noted. Typical values are at $T_A = +25^\circ\text{C}$. **Boldface limits apply over the operating temperature range, -40°C to +85°C.**

SYMBOL	PARAMETER	TEST CONDITIONS	ISL267452			UNITS
			MIN (Note 7)	TYP	MAX (Note 7)	
DYNAMIC PERFORMANCE						
SINAD	Signal-to (Noise + Distortion) Ratio	$f_{IN} = 100\text{kHz}$ VDD = +4.75V to +5.25V	70.0	71.4		dB
		$f_{IN} = 100\text{kHz}$ VDD = +3.0V to +3.6V	68.5	70.5		dB
THD	Total Harmonic Distortion	$f_{IN} = 100\text{kHz}$ VDD = +4.75V to +5.25V		-84	-76	dB
		$f_{IN} = 100\text{kHz}$ VDD = +3.0V to +3.6V		-84	-74	dB
SFDR	Spurious Free Dynamic Range	$f_{IN} = 100\text{kHz}$ VDD = +4.75V to +5.25V		-87	-76	dB
		$f_{IN} = 100\text{kHz}$ VDD = +3.0V to +3.6V		-85	-74	dB
IMD	Intermodulation Distortion	2nd and 3rd order, $f_{IN} = 90\text{kHz}, 110\text{kHz}$		-95		dB
tpd	Aperture Delay			1		ns
Δtpd	Aperture Jitter			15		ps
β3dB	Full Power Bandwidth	@ -3dB		15		MHz
DC ACCURACY						
N	Resolution		12			Bits
INL	Integral Nonlinearity		-1	±0.4	1	LSB
DNL	Differential Nonlinearity	Guaranteed no missed codes to 12 bits	-0.95	±0.3	0.95	LSB
OFFSET	Zero-Code Error	Zero Volt Differential Input	-6	±0.2	6	LSB
GAIN	Positive Gain Error	± VREF input range	-2	±0.1	2	LSB
	Negative Gain Error		-2	±0.1	2	LSB
ANALOG INPUT (Note 8)						
AIN	Full-Scale Input Span	2 x VREF		VIN+ - VIN-		V
VIN+, VIN-	Absolute Input Voltage Range					
	VIN+	$V_{CM} = V_{REF}$		$V_{CM} \pm V_{REF}/2$		V
	VIN-			$V_{CM} \pm V_{REF}/2$		V

Electrical Specifications VDD = +3.0V to +3.6V, f_{SCLK} = 10MHz, f_S = 555kSPS, VREF = 2.0V; VDD = +4.75V to +5.25V, f_{SCLK} = 10MHz, f_S = 555kSPS, VREF = 2.5V; V_{CM} = VREF, unless otherwise noted. Typical values are at T_A = +25 °C. **Boldface limits apply over the operating temperature range, -40 °C to +85 °C. (Continued)**

SYMBOL	PARAMETER	TEST CONDITIONS	ISL267452			UNITS
			MIN (Note 7)	TYP	MAX (Note 7)	
I _{LEAK}	Input DC Leakage Current		-1		1	μA
C _{VIN}	Input Capacitance	Track/Hold mode		13/5		pF
REFERENCE INPUT						
VREF	VREF Input Voltage Range	VDD = 3V (1% tolerance for specified performance)		2.0		V
		VDD = 5V (1% tolerance for specified performance)		2.5		V
I _{LEAK}	DC Leakage Current		-1		1	μA
C _{VREF}	VREF Input Capacitance	Track/Hold mode		21/18.5		pF
LOGIC INPUTS						
V _{IH}	Input High Voltage		2.4			V
V _{IL}	Input Low Voltage				0.8	V
I _{LEAK}	Input Leakage Current		-1		1	μA
C _{IN}	Input Capacitance			10		pF
LOGIC OUTPUTS						
V _{OH}	Output High Voltage	I _{SOURCE} = 200μA	VDD - 0.3			V
V _{OL}	Output Low Voltage	I _{SINK} = 200μA			0.4	V
I _{OZ}	Floating-State Output Current		-1		1	μA
C _{OUT}	Floating-State Output Capacitance			10		pF
	Output Coding		Two's Complement			
CONVERSION RATE						
t _{CONV}	Conversion Time	f _{SCLK} = 10MHz			1.6	μs
t _{ACQ}	Acquisition Time				200	ns
f _{max}	Throughput Rate				555	kSPS
POWER REQUIREMENTS						
VDD	Positive Supply Voltage Range		2.7		3.6	V
			4.75		5.25	V
I _{DD}	Positive Supply Input Current					
	Static				1	μA
	Dynamic	3V			1250	μA
		5V			1700	μA
	Power Dissipation					
	Static Mode	VDD = 3V			3	μW
		VDD = 5V			5	μW
	Dynamic	VDD = 3V, f _{smpl} = 555kSPS			3.75	mW
VDD = 5V, f _{smpl} = 555kSPS				8.5	mW	

NOTES:

- Compliance to datasheet limits is assured by one or more methods: production test, characterization and/or design.
- The absolute voltage applied to each analog input must be between GND and VDD to guarantee datasheet performance.

Timing Specifications Limits established by characterization and are not production tested. VDD = 3.0V to 3.6V, $f_{SCLK} = 10\text{MHz}$, $f_S = 555\text{kSPS}$, VREF = 2.0V; VDD = 4.75V to 5.25V, $f_{SCLK} = 10\text{MHz}$, $f_S = 555\text{kSPS}$, VREF = 2.5V; $V_{CM} = V_{REF}$ unless otherwise noted. **Boldface limits apply over the operating temperature range, -40°C to +85°C.**

SYMBOL	PARAMETER	TEST CONDITIONS	MIN (Note 7)	TYP	MAX (Note 7)	UNITS
f _{SCLK}	Clock Frequency		0.01		10	MHz
t _{SCLK}	Clock Period		100			ns
t _{ACQ}	Acquisition Time				200	ns
t _{CONV}	Conversion Time				1.6	μs
t _{CSW}	\overline{CS} Pulse Width		10			ns
t _{CSS}	\overline{CS} Falling Edge to S _{CLK} Falling Edge Setup Time		10			ns
t _{CDV}	\overline{CS} Falling Edge to SDATA Valid				20	ns
t _{CLKDV}	SCLK Falling Edge to SDATA Valid				40	ns
t _{SDH}	SCLK Falling Edge to SDATA Hold		10			ns
t _{SW}	SCLK Pulse Width		0.4 x t_{SCLK}			ns
t _{DISABLE}	SCLK Falling Edge to SDATA Disable Time (Note 9)	Extrapolated back to true bus relinquish	10		35	ns
t _{QUIET}	Quiet Time Before Sample		60			ns

NOTE:

- 9. During characterization, t_{DISABLE} is measured from the release point with a 10pF load (see Figure 4) and the equivalent timing using the AD7452 loading (25pF) is calculated.

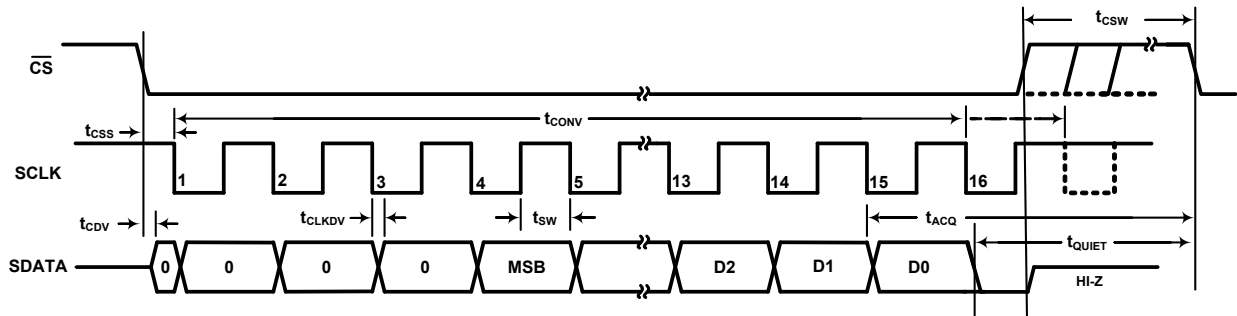


FIGURE 3. SERIAL INTERFACE TIMING DIAGRAM

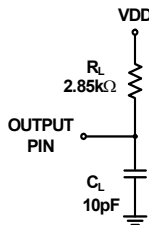


FIGURE 4. EQUIVALENT LOAD CIRCUIT

Typical Performance Characteristics

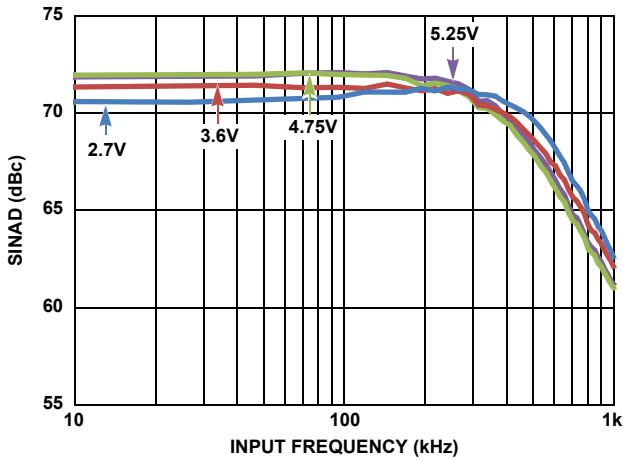


FIGURE 5. ISL267452 SINAD vs ANALOG INPUT FREQUENCY FOR VARIOUS SUPPLY VOLTAGES

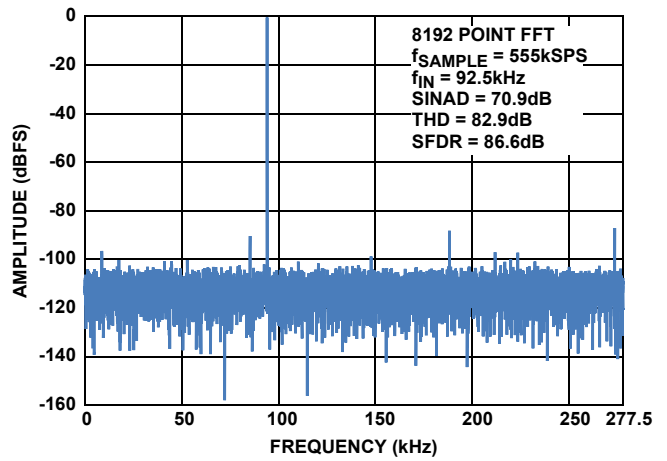


FIGURE 6. ISL267452 DYNAMIC PERFORMANCE WITH VDD = 3V

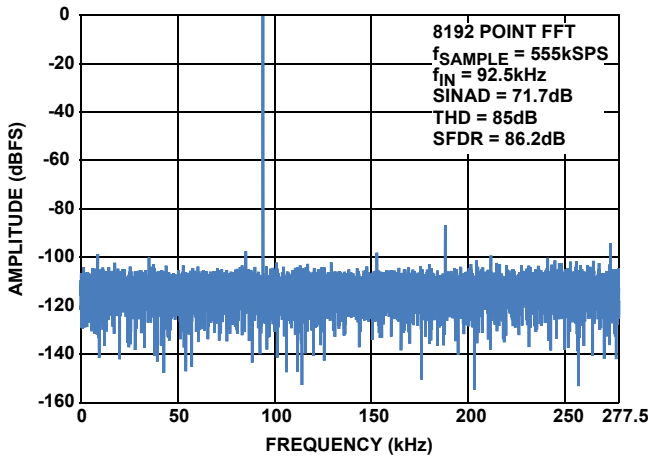


FIGURE 7. ISL267452 DYNAMIC PERFORMANCE WITH VDD = 5V

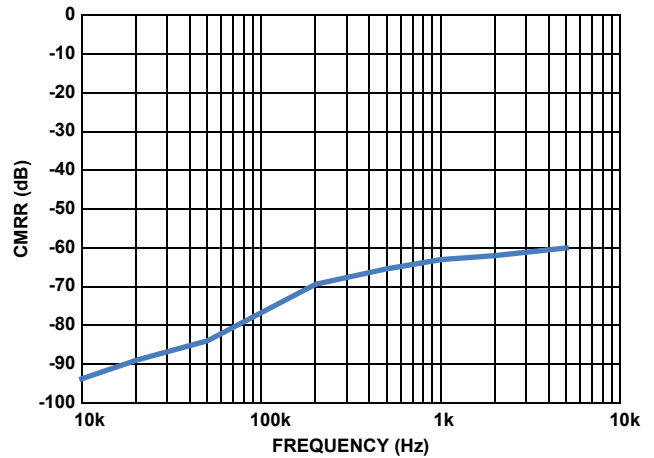


FIGURE 8. CMRR vs FREQUENCY FOR VDD = 5V

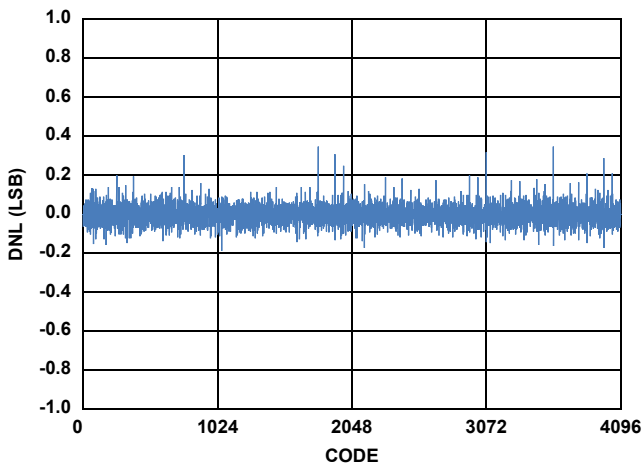


FIGURE 9. TYPICAL DNL FOR THE ISL267452 FOR VDD = 5V

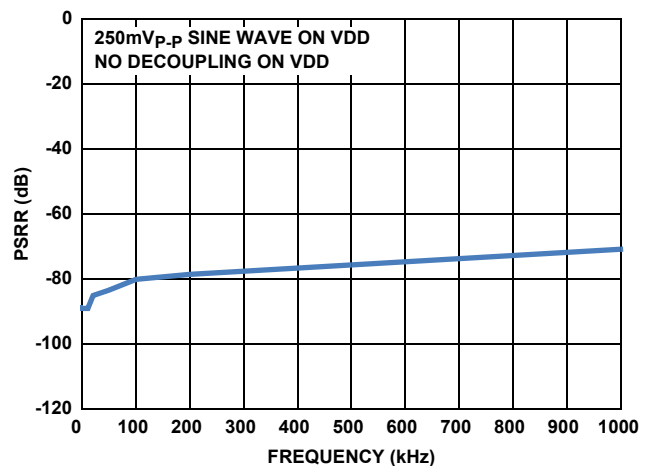


FIGURE 10. PSRR vs SUPPLY RIPPLE FREQUENCY WITHOUT SUPPLY DECOUPLING

Typical Performance Characteristics (Continued)

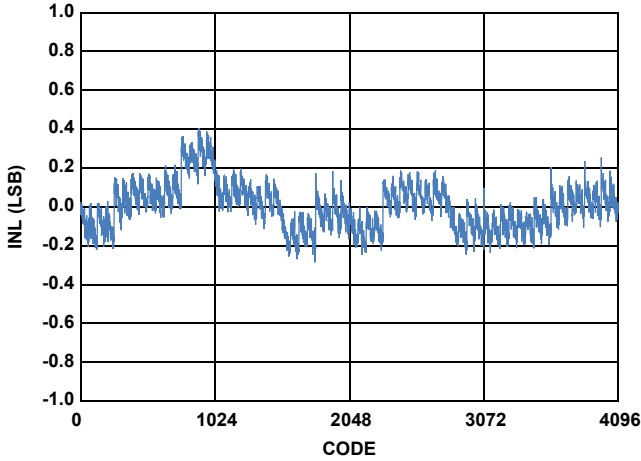


FIGURE 11. TYPICAL INL FOR THE ISL267452 FOR VDD = 5V

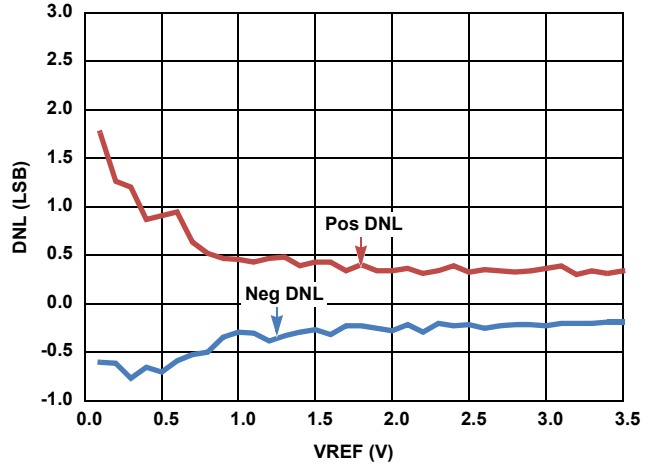


FIGURE 12. CHANGE IN DNL vs VREF FOR THE ISL267452 FOR VDD = 5V

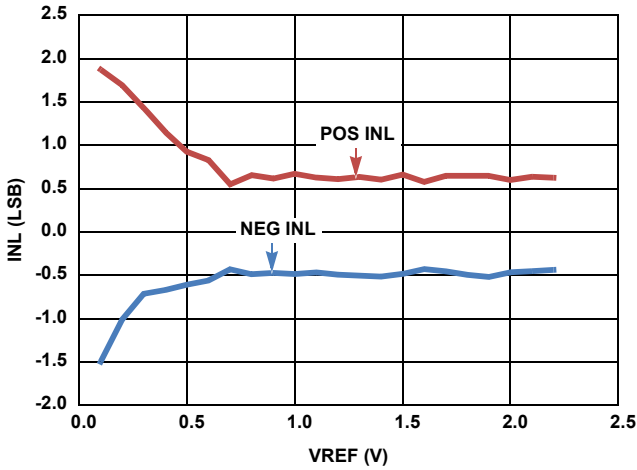


FIGURE 13. CHANGE IN INL vs VREF FOR THE ISL267452 FOR VDD = 3V

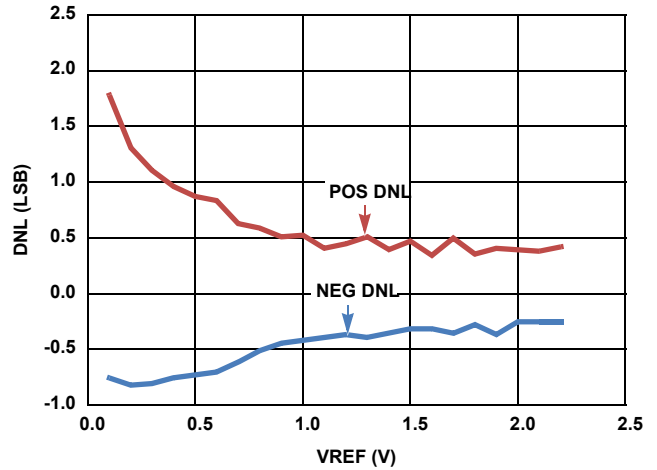


FIGURE 14. CHANGE IN DNL vs VREF FOR THE ISL267452 FOR VDD = 3V

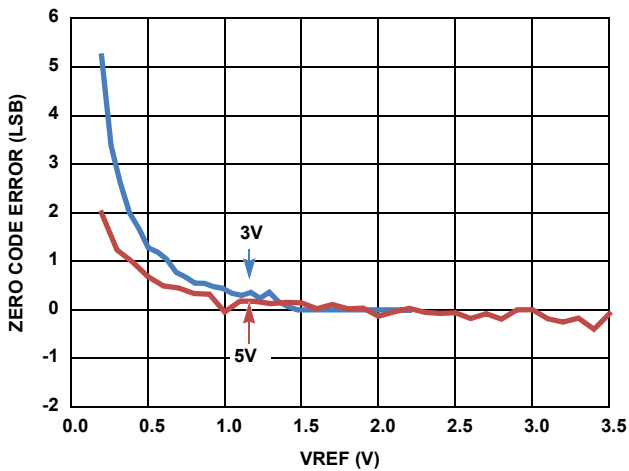


FIGURE 15. CHANGE IN OFFSET ERROR vs REFERENCE VOLTAGE FOR VDD = 5V AND 3V FOR THE ISL267452

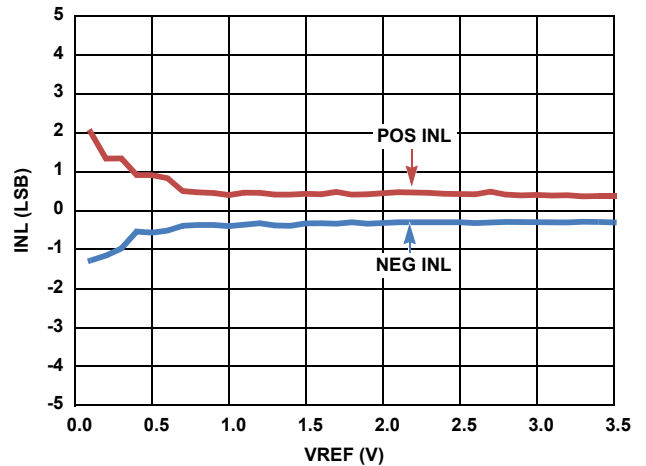


FIGURE 16. CHANGE IN INL vs VREF FOR THE ISL267452 FOR VDD = 5V

Typical Performance Characteristics (Continued)

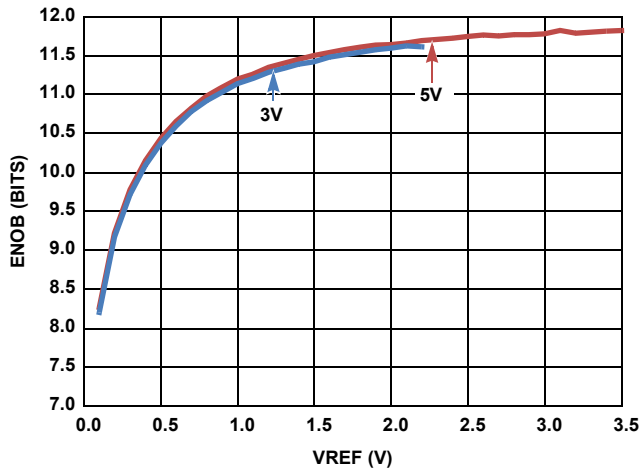


FIGURE 17. CHANGE IN ENOB vs REFERENCE VOLTAGE FOR VDD = 5V AND 3V FOR THE ISL267452

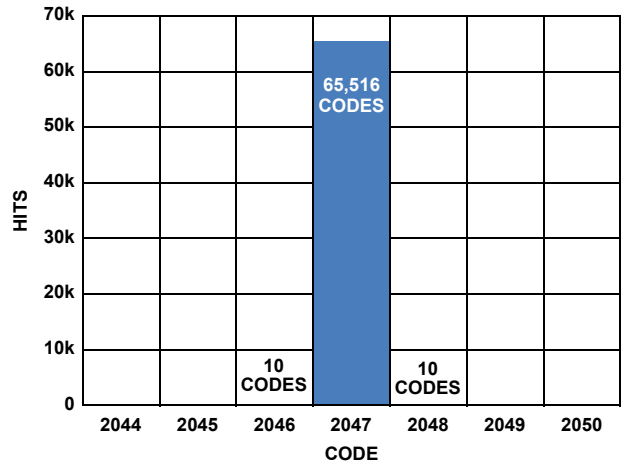


FIGURE 18. HISTOGRAM OF 10,000 CONVERSIONS OF A DC INPUT FOR THE ISL267452 WITH VDD = 5V

Functional Description

The ISL267452 is based on a successive approximation register (SAR) architecture utilizing capacitive charge redistribution digital to analog converters (DACs). Figure 19 shows a simplified representation of the converter. During the acquisition phase (ACQ) the differential input is stored on the sampling capacitors (CS). The comparator is in a balanced state since the switch across its inputs is closed. The signal is fully acquired after t_{ACQ} has elapsed, and the switches then transition to the conversion phase (CONV) so the stored voltage may be converted to digital format. The comparator will become unbalanced when the differential switch opens and the input switches transition (assuming that the stored voltage is not exactly at mid-scale). The comparator output reflects whether the stored voltage is above or below mid-scale, which sets the value of the MSB. The SAR logic then forces the capacitive DACs to adjust up or down by one quarter of full-scale by switching in binarily weighted capacitors. Again, the comparator output reflects whether the stored voltage is above or below the new value, setting the value of the next lowest bit. This process repeats until all 12 bits have been resolved.

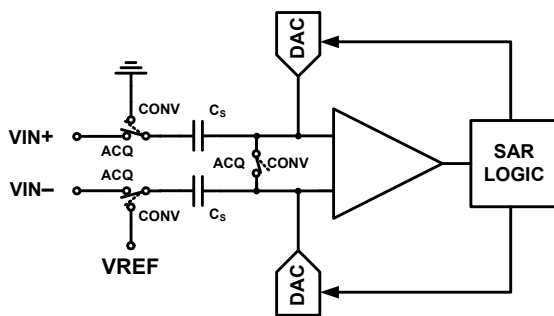


FIGURE 19. SAR ADC ARCHITECTURAL BLOCK DIAGRAM

An external clock must be applied to the SCLK pin to generate a conversion result. The allowable frequency range for SCLK is 10kHz to 10MHz (555kSPS). Serial output data is transmitted on the falling edge of SCLK. The receiving device (FPGA, DSP or Microcontroller) may latch the data on the rising edge of SCLK to maximize set-up and hold times.

A stable, low-noise reference voltage must be applied to the VREF pin to set the full-scale input range and common-mode voltage. See “Voltage Reference Input” on page 11 for more details.

ADC Transfer Function

The output coding for the ISL267452 is twos complement. The first code transition occurs at successive LSB values (i.e., 1 LSB, 2 LSB, and so on). The LSB size of the ISL267452 is $2 \cdot VREF / 4096$. The ideal transfer characteristic of the ISL267452 is shown in Figure 20.

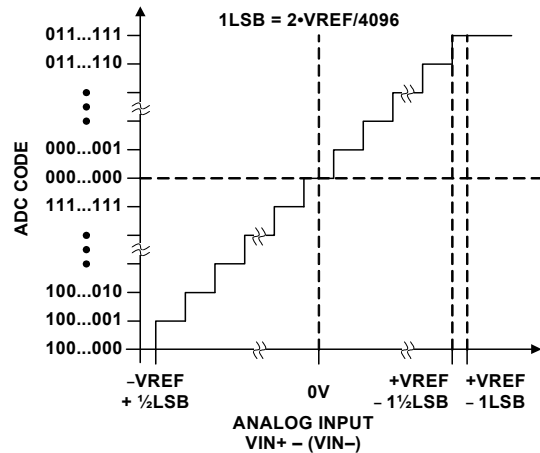


FIGURE 20. IDEAL TRANSFER CHARACTERISTICS

Analog Input

The ISL267452 features a fully differential input with a nominal full-scale range equal to twice the applied VREF voltage. Each input swings V_{REF} V_{p-p} , 180° out-of-phase from one another for a total differential input of $2 \cdot V_{REF}$ (refer to Figure 21). Differential signaling offers several benefits over a single-ended input, such as:

- Doubling of the full-scale input range (and therefore the dynamic range)
- Improved even order harmonic distortion
- Better noise immunity due to common mode rejection

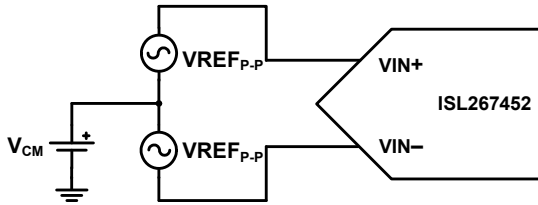


FIGURE 21. DIFFERENTIAL INPUT SIGNALING

Figure 22 shows the relationship between the reference voltage and the full-scale input range for two different values of VREF.

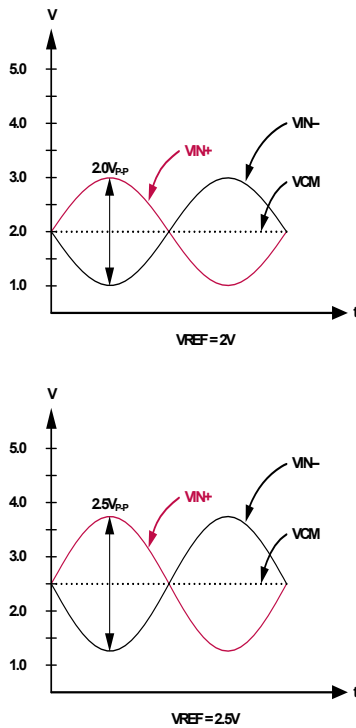


FIGURE 22. RELATIONSHIP BETWEEN VREF AND FULL-SCALE RANGE

Note that there is a trade-off between VREF and the allowable common mode input voltage (VCM). The full-scale input range is proportional to VREF; therefore the VCM range must be limited for larger values of VREF in order to keep the absolute maximum and minimum voltages on the VIN+ and VIN- pins within specification. Figures 23 and 24 illustrate this relationship for 5V and 3V operation, respectively. The dashed lines show the theoretical VCM range based solely on keeping the VIN+ and VIN- pins within the supply rails. Additional restrictions are imposed due to the required headroom of the input circuitry, resulting in practical limits shown by the shaded area.

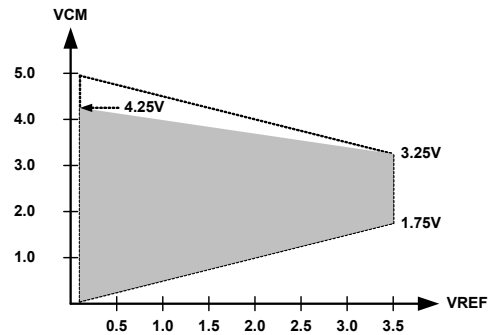


FIGURE 23. RELATIONSHIP BETWEEN VREF AND VCM FOR VDD = 5V

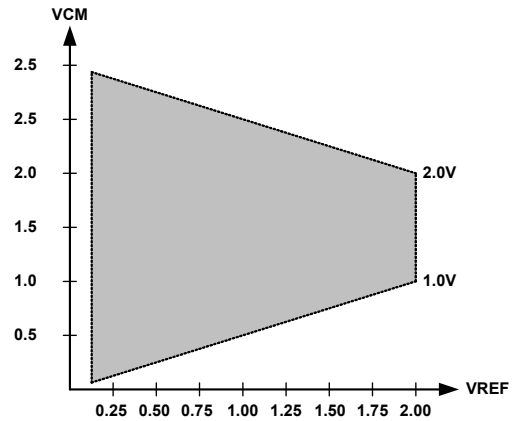


FIGURE 24. RELATIONSHIP BETWEEN VREF AND VCM FOR VDD = 3V

Voltage Reference Input

An external low-noise reference voltage must be applied to the VREF pin to set the full-scale input range of the converter. The reference input accepts voltages ranging from 0.1V to 2.2V for 3V operation and 0.1V to 3.5V for 5V operation. The device is specified with a reference voltage of 2.5V for 5V operation and 2.0V for 3V operation.

Figures 26 and 27 illustrate possible voltage reference options for the ISL267452. Figure 26 uses the precision ISL21090 voltage reference, which exhibits exceptionally low drift and low noise. The ISL21090 must use a power supply greater than 4.7V. The VREF input pin of the ISL267452 uses very low current, so the decoupling capacitor can be small (0.1µF).

Figure 27 illustrates the ISL21010 voltage reference being used with the ISL267452. The ISL21010 series voltage references have higher noise and drift than the ISL26090 devices, but they consume very low operating current and are excellent for battery-powered applications.

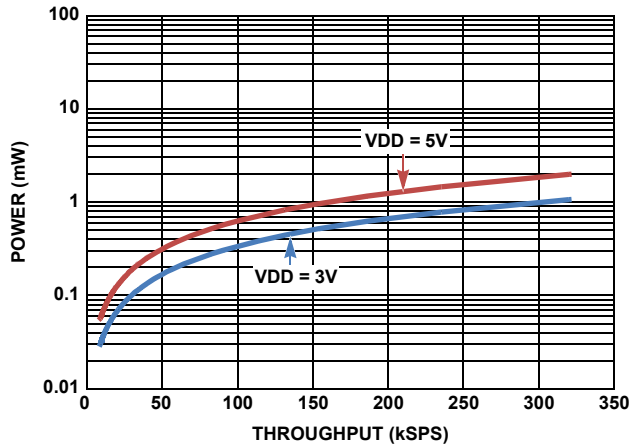


FIGURE 25. POWER CONSUMPTION vs THROUGHPUT RATE

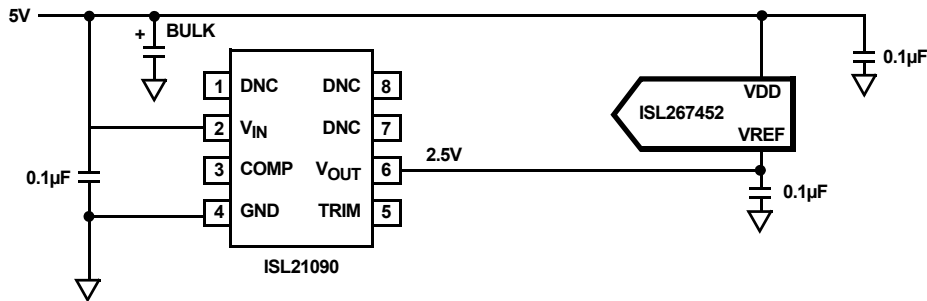


FIGURE 26. PRECISION VOLTAGE REFERENCE FOR +5V SUPPLY

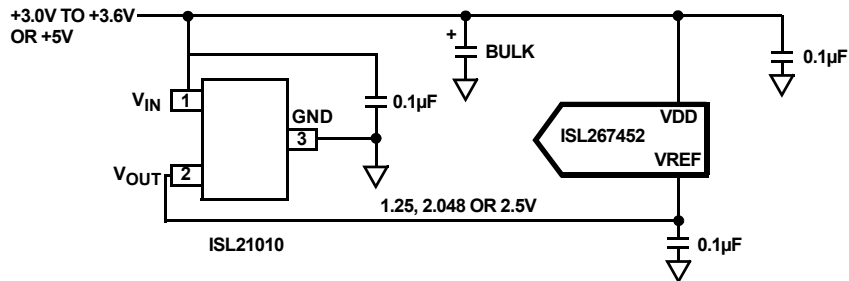


FIGURE 27. VOLTAGE REFERENCE FOR +3.0V TO +3.6V, OR FOR +5V SUPPLY

Converter Operation

The ISL267452 is designed to minimize power consumption by only powering up the SAR comparator during conversion time. When the converter is in track mode (its sample capacitors are tracking the input signal) the SAR comparator is powered down. The state of the converter is dictated by the logic state of \overline{CS} . When \overline{CS} is high, the SAR comparator is powered down while the sampling capacitor array is tracking the input. When \overline{CS} transitions low, the capacitor array immediately captures the analog signal that is being tracked. After \overline{CS} is taken low, the SCLK pin is toggled 16 times. For the first 3 clocks, the comparator is powered up and auto-zeroed, then the SAR decision process is begun. This process uses 12 SCLK cycles. Each SAR decision is presented to the SDATA output on the next clock cycle after the SAR decision is performed. The SAR process

(12 bits) is completed on SCLK cycle 15. At this point in time, the SAR comparator is powered down and the capacitor array is placed back into Track mode. The last SAR comparator decision is output from SDATA on the 16th SCLK cycle. When the last data bit is output from SDATA, the output switches to a logic 0 until \overline{CS} is taken high, at which time, the SDATA output enters a High-Z state.

Figure 28 on page 13 illustrates the system timing for the ISL267452.

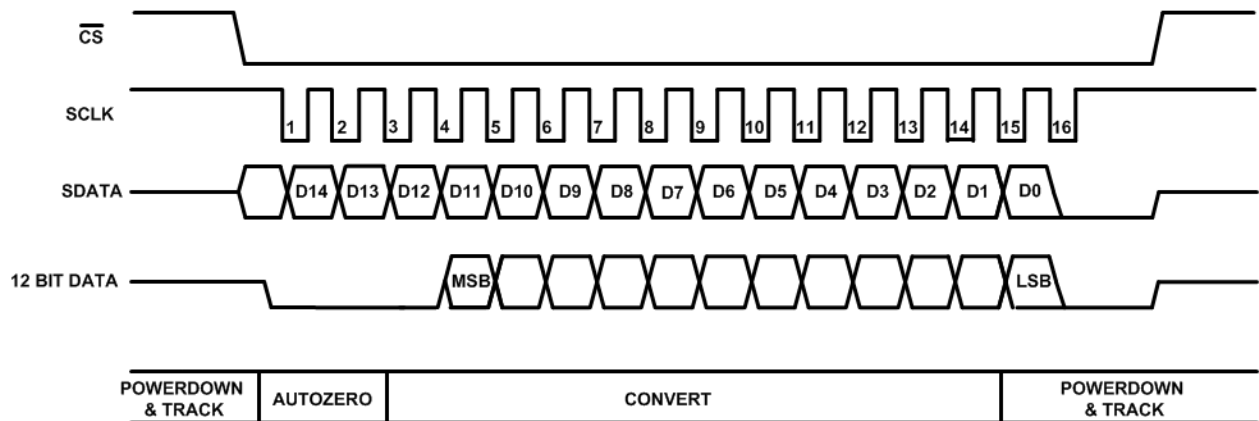


FIGURE 28. ISL267452 SYSTEM TIMING

Power-On Reset

When power is first applied, the ISL267452 performs a power-on reset that requires approximately 2.5ms to execute. After this is complete, a single dummy conversion must be executed (by taking \overline{CS} low) in order to initialize the switched capacitor track and hold. The dummy conversion cycle will take 1.6 μ s with an 10MHz SCLK. Once the dummy cycle is complete, the ADC mode will be determined by the state of \overline{CS} . Regular conversions can be started immediately after this dummy cycle is completed and time has been allowed for proper acquisition.

Acquisition Time

To achieve the maximum sample rate (555kSps) in the ISL267452 device, the maximum acquisition time is 200ns. For slower conversion rates, or for conversions performed using a slower SCLK value than 10MHz, the minimum acquisition time is 200ns. This minimum acquisition time also applies to all the devices if short cycling is utilized.

Short Cycling

In cases where a lower resolution conversion is acceptable, \overline{CS} can be pulled high before all SCLK falling edges have elapsed. This is referred to as short cycling, and it can be used to further optimize power dissipation. In this mode, a lower resolution result will be output, but the ADC will enter static mode sooner and exhibit a lower average power consumption than if the complete conversion cycle were carried out. The minimum acquisition time (t_{ACQ}) requirement of 200ns must be met for the next conversion to be valid.

Application Hints

Grounding and Layout

The printed circuit board that houses the ISL267452 should be designed so that the analog and digital sections are separated and confined to certain areas of the board. This facilitates the use of ground planes that can be easily separated. A minimum etch technique is generally best for ground planes since it gives the best shielding. Digital and analog ground planes should be joined in only one place, and the connection should be a star ground point established as close to the GND pin on the ISL267452 as possible. Avoid running digital lines under the device, as this will couple noise onto the die. The analog ground plane should be allowed to run under the ISL267452 to avoid noise coupling.

The power supply lines to the device should use as large a trace as possible to provide low impedance paths and reduce the effects of glitches on the power supply line.

Fast switching signals, such as clocks, should be shielded with digital ground to avoid radiating noise to other sections of the board, and clock signals should never run near the analog inputs. Avoid crossover of digital and analog signals. Traces on opposite sides of the board should run at right angles to each other. This reduces the effects of feedthrough through the board. A microstrip technique is by far the best but is not always possible with a double-sided board.

In this technique, the component side of the board is dedicated to ground planes, while signals are placed on the solder side.

Good decoupling is also important. All analog supplies should be decoupled with μ F tantalum capacitors in parallel with 0.1 μ F capacitors to GND. To achieve the best from these decoupling components, they must be placed as close as possible to the device.

Terminology

Signal-to-(Noise + Distortion) Ratio (SINAD)

This is the measured ratio of signal-to-(noise + distortion) at the output of the ADC. The signal is the rms amplitude of the fundamental. Noise is the sum of all nonfundamental signals up to half the sampling frequency ($f_s/2$), excluding DC. The ratio is dependent on the number of quantization levels in the digitization process; the more levels, the smaller the quantization noise. The theoretical signal-to-(noise + distortion) ratio for an ideal N-bit converter with a sine wave input is given by Equation 1:

$$\text{Signal-to-(Noise + Distortion)} = (6.02 N + 1.76)\text{dB} \quad (\text{EQ. 1})$$

Thus, for a 12-bit converter, this is 74dB.

Total Harmonic Distortion

Total harmonic distortion (THD) is the ratio of the rms sum of harmonics to the fundamental. For the ISL267452, it is defined as Equation 2:

$$\text{THD(dB)} = 20\log \frac{\sqrt{V_2^2 + V_3^2 + V_4^2 + V_5^2 + V_6^2}}{V_1} \quad (\text{EQ. 2})$$

where V_1 is the rms amplitude of the fundamental and V_2 , V_3 , V_4 , V_5 , and V_6 are the rms amplitudes of the second to the sixth harmonics.

Peak Harmonic or Spurious Noise (SFDR)

Peak harmonic or spurious noise is defined as the ratio of the rms value of the next largest component in the ADC output spectrum (up to $f_s/2$ and excluding DC) to the rms value of the fundamental (also referred to as Spurious Free Dynamic Range (SFDR)). Normally, the value of this specification is determined by the largest harmonic in the spectrum, but for ADCs where the harmonics are buried in the noise floor, it will be a noise peak.

Intermodulation Distortion

With inputs consisting of sine waves at two frequencies, f_a and f_b , any active device with nonlinearities will create distortion products at sum and difference frequencies of $m f_a \pm n f_b$ where m and $n = 0, 1, 2$ or 3 . Intermodulation distortion terms are those for which neither m nor n are equal to zero. For example, the second order terms include $(f_a + f_b)$ and $(f_a - f_b)$, while the third order terms include $(2f_a + f_b)$, $(2f_a - f_b)$, $(f_a + 2f_b)$, and $(f_a - 2f_b)$.

The ISL267452 is tested using the CCIF standard, where two input frequencies near the top end of the input bandwidth are used. In this case, the second order terms are usually distanced in frequency from the original sine waves, while the third order terms are usually at a frequency close to the input frequencies. As a result, the second and third order terms are specified separately. The calculation of the intermodulation distortion is as per the THD specification, where it is the ratio of the rms sum of the individual distortion products to the rms amplitude of the sum of the fundamentals expressed in dBs.

Aperture Delay

This is the amount of time from the leading edge of the sampling clock until the ADC actually takes the sample.

Aperture Jitter

This is the sample-to-sample variation in the effective point in time at which the actual sample is taken.

Full Power Bandwidth

The full power bandwidth of an ADC is that input frequency at which the amplitude of the reconstructed fundamental is reduced by 3dB for a full-scale input.

Common-Mode Rejection Ratio (CMRR)

The common-mode rejection ratio is defined as the ratio of the power in the ADC output at full-scale frequency, f , to the power of a 250mV_{P-P} sine wave applied to the common-mode voltage of V_{IN+} and V_{IN-} of frequency f_s :

$$\text{CMRR(dB)} = 10\log(P_f/P_{f_s}) \quad (\text{EQ. 3})$$

P_f is the power at the frequency f in the ADC output; P_{f_s} is the power at frequency f_s in the ADC output.

Integral Nonlinearity (INL)

This is the maximum deviation from a straight line passing through the endpoints of the ADC transfer function.

Differential Nonlinearity (DNL)

This is the difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.

Zero-Code Error

This is the deviation of the midscale code transition ($111\dots111$ to $000\dots000$) from the ideal $V_{IN+} - V_{IN-}$ (i.e., 0 LSB).

Positive Gain Error

This is the deviation of the last code transition ($011\dots110$ to $011\dots111$) from the ideal $V_{IN+} - V_{IN-}$ (i.e., $+REF - 1$ LSB), after the zero code error has been adjusted out.

Negative Gain Error

This is the deviation of the first code transition ($100\dots000$ to $100\dots001$) from the ideal $V_{IN+} - V_{IN-}$ (i.e., $-REF + 1$ LSB), after the zero code error has been adjusted out.

Track and Hold Acquisition Time

The track and hold acquisition time is the minimum time required for the track and hold amplifier to remain in track mode for its output to reach and settle to within 0.5 LSB of the applied input signal.

Power Supply Rejection Ratio (PSRR)

The power supply rejection ratio is defined as the ratio of the power in the ADC output at full-scale frequency, f , to ADC VDD supply of frequency f_s . The frequency of this input varies from 1kHz to 1MHz.

$$\text{PSRR(dB)} = 10\log(P_f/P_{f_s}) \quad (\text{EQ. 4})$$

P_f is the power at frequency f in the ADC output; P_{f_s} is the power at frequency f_s in the ADC output.

Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to web to make sure you have the latest revision.

DATE	REVISION	CHANGE
July 26, 2012	FN8255.0	Initial Release.

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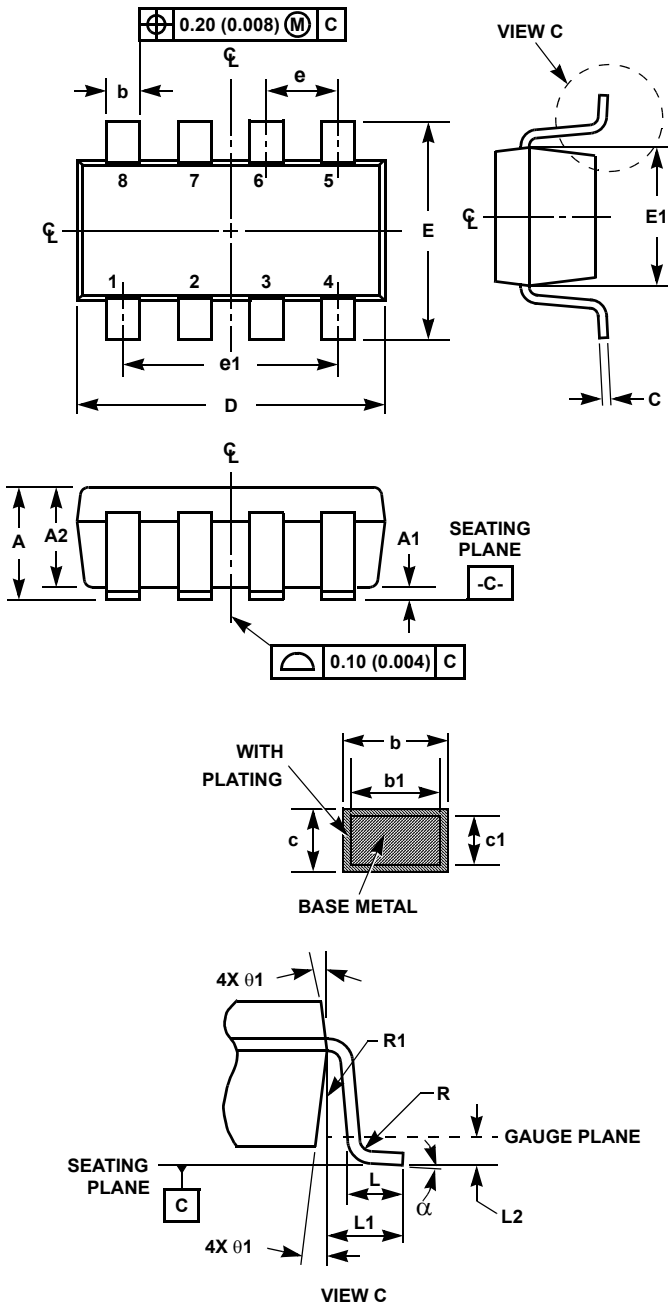
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Small Outline Transistor Plastic Packages (SOT23-8)



P8.064

8 LEAD SMALL OUTLINE TRANSISTOR PLASTIC PACKAGE

SYMBOL	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.036	0.057	0.90	1.45	-
A1	0.000	0.0059	0.00	0.15	-
A2	0.036	0.051	0.90	1.30	-
b	0.009	0.015	0.22	0.38	-
b1	0.009	0.013	0.22	0.33	-
c	0.003	0.009	0.08	0.22	6
c1	0.003	0.008	0.08	0.20	6
D	0.111	0.118	2.80	3.00	3
E	0.103	0.118	2.60	3.00	-
E1	0.060	0.067	1.50	1.70	3
e	0.0256 Ref		0.65 Ref		-
e1	0.0768 Ref		1.95 Ref		-
L	0.014	0.022	0.35	0.55	4
L1	0.024 Ref.		0.60 Ref.		-
L2	0.010 Ref.		0.25 Ref.		-
N	8		8		5
R	0.004	-	0.10	-	-
R1	0.004	0.010	0.10	0.25	-
α	0°	8°	0°	8°	-

Rev. 2 9/03

NOTES:

1. Dimensioning and tolerance per ASME Y14.5M-1994.
2. Package conforms to EIAJ SC-74 and JEDEC MO178BA.
3. Dimensions D and E1 are exclusive of mold flash, protrusions, or gate burrs.
4. Footlength L measured at reference to gauge plane.
5. "N" is the number of terminal positions.
6. These Dimensions apply to the flat section of the lead between 0.08mm and 0.15mm from the lead tip.
7. Controlling dimension: MILLIMETER. Converted inch dimensions are for reference only

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